Docket No

295715US26PCT

TENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Masaru SASAKI, et al.

SERIAL NO: 10/591,343

2813 GAU:

EXAMINER: Maliheh Malek FILED: August 31, 2006 METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE AND PLASMA OXIDATION METHOD FOR:

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR-

Applicant(s) wish to disclose the following information.

REFERENCES

- The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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SHEET 1 OF 1

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Form PTO 1449 (Modified)		U.S. DEPARTMENT PATENT AND TRA	OMMERCE DEM OFFICE	ATT DOCKET NO. 715US26PCT APPLICANT		SERIAL NO. 10/591,343	
TRADE				APPLICANT		10/591,545	
LIST OF	REFE	RENCES CITED BY AF					
2.0.0.			LIGHT	Masaru SASAKI, et al.			
				FILING DATE August 31, 2006		GROUP 2813	
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
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44147		NUMBER	DATE	COUNTRY		YES NO	
/M.M./	AO	2000 332245	11/30/2000	JP (with English abstract)			NO
/M.M./	AP	08 102534	04/16/1996	JP (with English abstract)			NO
/M.M./	AQ	11 293470	10/26/1999	JP (with English abstract)			NO
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Examiner /Maliheh Malek/					Date Considered 10/10/2008		
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U.S. PCT Application Serial No: 10/591,343

Filed: August 31, 2006 Masaru SASAKI, et al. Docket No. 295715 US

STATEMENT OF RELEVANCY

- References AO-AP have been cited in the International Search Report. A copy of these references is being submitted herewith.
- References have been cited in the corresponding copy of these references is being submitted herewith.
- Reference AQ is discussed in the specification. A copy of that reference is being submitted herewith.
- 4) References are additional prior art known to Applicant. A copy of these references is being submitted herewith.